# CWQ1100<sup>®</sup> Datasheet



Qi Compliant 15W Wireless Power Receiver IC

## **General Description**

CWQ1100 can deliver up to 15W as a highly-integrated single-chip wireless medium power receiver IC. As wireless power transfer systems are getting more popular, they require more fast charging and high efficiency solution. The CWQ1100 wireless power receiver IC is compliant with WPC 1.2.4 standard and supports the 5W baseband power profile (BPP) and 15W extended power profile (EPP). The CWQ1100 power receiver integrates a synchronous rectifier, a low drop-out regulator, and communication controllers which use Amplitude Shift Keying (ASK) and Frequency Shift Keying (FSK). The chip also supports the Foreign Object Detection (FOD) extension in WPC 1.2.4. For achieving chip stability, protection tools are implemented, such as over-current-protection, over-voltage-protection, thermal shutdown, and under voltage lock-out (UVLO). Configurable analog blocks can be used independently and co-operated with the control and communication unit.

## **Features Overview**

- Single-chip dual mode 15W receiver for WPC 1.2.4 compliance
  - WPC 1.2.4 TPT#MP1 (15W)
- Support 5W baseline power profile (BPP) and 15W extended power profile (EPP)
- FOD extension supports
- Integrated Synchronous Rectifier Receiver.
  - Support Output Power up to 15W.
  - High Rectifier Efficiency up to 95%.
  - High System Efficiency up to 90%.
  - Topology Auto Selection operation.
- Programmable Dynamic Rectifier Voltage Control.
- Integrated Programmable Linear Regulator.
  - Output voltage range of 4.5-12V with 0.5V control step.
    - Output current limit up to 2A.
- Bi-directional channel communication
  - FSK demodulation for PTx to PRx
  - ASK modulation for PRx to PTx
- 24-bit Power Calculation support
- Received Power Calculation for FOD function
  - 12-bit ADC for voltage/current measurement.

- Adaptive Coil Power loss/offset compensation.
- Programmable Temperature Control.
- Charger Complete and Enable control inputs
- End of Power Transfer (EPT) Packet management.
- Over Current Limit
- Over Voltage Protection
- Thermal Shutdown
- WLCSP 50B 2.64mm x 3.94mm, 0.4mm pitch
- QFN 40-pin 6mm x 6mm, 0.5mm pitch
- 384-bit One-Time-Programmable Device

## Applications

- WPC Compliant Receivers.
- Cell phones and smart phones.
- Digital Cameras.
- Power Banks.
- Wireless Power Embedded Batteries
- Bluetooth Headsets
- Portable Media Players
- Other Hand-held Device

# 1. Description for Implementation

#### Datasheet (REV. 2.2)

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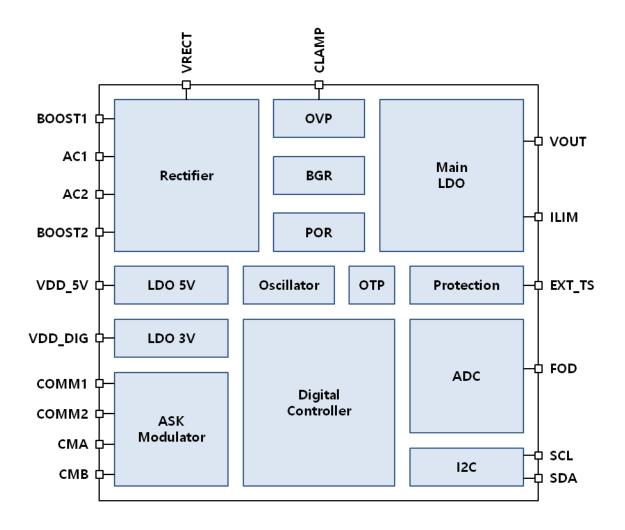


Figure 1. CWQ1100 Block Diagram

#### 1.1 Overview

A wireless power charging system is composed of transmitter and receiver. In general, wireless power transmitter will transfer AC power using a power amplifier through a TX inductor coil. Then wireless power receiver will receive AC power through an RX inductor coil which is strongly coupled with the TX coil. In receiver part, rectifier will change the AC power to DC power and LDO will transfer the DC power to battery charger.

Figure1 shows the block diagram of CWQ1100 wireless charging receiver IC. CWQ1100 receiver will support power transfer up to 15W and it is compliant with WPC1.2.4 standards. It consists of rectifier, main LDO, internal LDOs, ADC, digital controller and etc.

### 1.2 Rectifier

CWQ1100 employs a synchronous active rectifier in order to improve AC to DC power conversion efficiency. The rectifier power conversion efficiency is very important because it has a large influence on overall receiver efficiency. The rectifier in CWQ1100 will support full-wave, half-wave and passive mode according to the transferred power level. When the power transfer is started initially, the rectifier will operate in passive mode and supply the system power to overall receive IC.

### 1.3 Main LDO



Main LDO regulator will transfer DC power from rectifier output to battery charger. LDO in CWQ1100 is designed to transfer power up to 15W and its output voltage level can be changed by user. The LDO power transistor is designed to minimize its on-resistance because the LDO drop-out voltage is directly related to overall system efficiency. Especially, in case of large power transfer, the LDO drop-out voltage (VRECT-VOUT) should be controlled as small as possible.

#### 1.4 ASK Modulator

CWQ1100 power receiver communicates with the power transmitter by ASK modulator. The ASK modulator make up the WPC standard 2kHz bi-phase signal by switching the capacitors between COMM1/2 and AC1/AC2. Switching the capacitance at AC1/AC2 nodes will change the impedance of transmitter coil. As a result, amplitude modulation is built up.

#### 1.5 ADC

CWQ1100 power receiver employs 12-bit SAR ADC because it has low power, small area characteristics and moderate speed performance. ADC monitors important internal voltages and currents and gives the system information to the digital controller.

#### 1.6 Protection

CWQ1100 power receiver employs various protection schemes in order to prevent system damage. When the VRECT voltage is too high, the OVP (Over Voltage Protection) function will turn on the clamp path or send the EPT (End Power Transfer) packet to the transmitter. When the main LDO current is too large, the OCL (Over Current Limit) function will limit the output current. When the temperature inside or outside the chip is too high, the OTP (Over Temperature Protection) function will send the EPT packet to transmitter or shutdown the receiver system.

#### 1.7 Digital Controller

Digital controller in CWQ1100 controls all the analog blocks and entire system to perform power transfer operation according to the wireless power transfer standard, that is, WPC 1.2.4. It also supports I2C interface to communicate with external host.



# 2. Pin-out and description

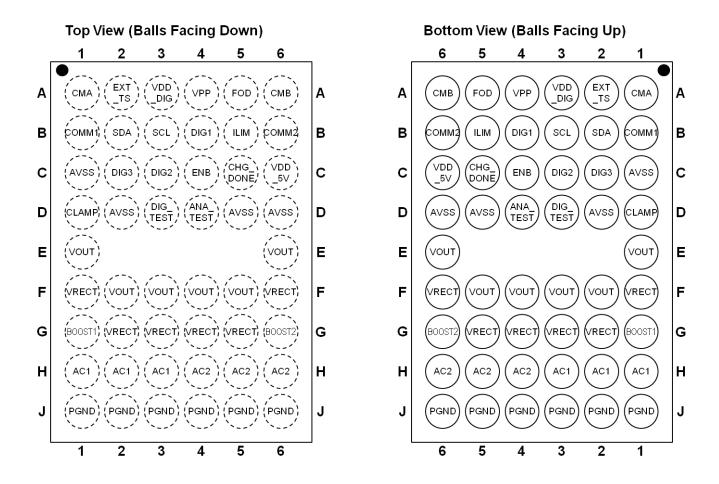


Figure 2. CWQ1100 Pin Configuration (WLCSP 50B 2.64mm x 3.94mm, 0.4mm pitch)

### 2.1 Pin Description (WLCSP 50B 2.64mm x 3.94mm, 0.4mm pitch)

| Pin Number | Name    | Туре | Description   |
|------------|---------|------|---|
| A1         | CMA     | 0    | NC  |
| A6         | СМВ     | 0    |   |
| A2         | EXT_TS  | Ι    | External temperature sensor input. Connect this pin to external NTC thermistor. If not used, connect this pin to VDD_DIG. |
| A3         | VDD_DIG | Ρ    | Internal 3V LDO output for digital block and etc. 1uF capacitor connect to GND. Not for external use                      |
| A4         | VPP     | I    | 8V high voltage power for OTP programming. During the normal operation, connect this pin to VDD_DIG.                      |
| A5         | FOD     | I    | FOD offset setting pin. Connect a resistor between this pin and GND.  |
| B1         | COMM1   | 0    | High voltage open drain output for ASK modulation. Connect 47nF capacitor   |
| B6         | COMM2   | 0    | from AC1/AC2 to COMM1/COMM2 separately  |
| B2         | SDA     | I/0  | I <sup>2</sup> C data input/output for internal register access.  |



| B3                   | SCL      | Ι | I <sup>2</sup> C clock input for internal register access.                                       |
|----------------------|----------|---|--|
| B4                   | DIG1     | I | Enable scan test mode. Connect to GND directly in normal application.                            |
| B5                   | ILIM     | I | Output current or over-current limit level programming pin.                                      |
| C1,D2,D5,D6          | AVSS     | Р | Analog ground pin.   |
| C2                   | DIG3     | I | Scan clock for scan test mode. Connect to GND directly in normal application.                    |
| C3                   | DIG2     | I | Scan enable for scan test mode. Connect to GND directly in normal application.                   |
| C4                   | ENB      | I | Active-low enable pin for the entire chip.   |
| C5                   | CHG_DONE | I | Active-high input from the external battery charger to terminate power transfer.                 |
| C6                   | VDD_5V   | Р | Internal 5V LDO output pin for 1uF capacitor connection. Not for external use                    |
| D1                   | CLAMP    | 0 | High voltage open drain output for analog linear over-voltage protection.                        |
| D3                   | DIG_TEST | 0 | Digital test output pin. Floating for normal application   |
| D4                   | ANA_TEST | 0 | Analog test output pin. Floating for normal application  |
| E1,E6,F2,F3<br>F4,F5 | VOUT     | Ρ | Main LDO output pin for delivering power to the battery charger. 3.3uF capacitor connect to GND. |
| F1,F6,G2,G3<br>G4,G5 | VRECT    | Ρ | Internal synchronous rectifier output for 20uF capacitor connection.                             |
| G1                   | BOOST1   | 0 | Bootstrap capacitor connection pin for driving the high-side FETs of                             |
| G6                   | BOOST2   | 0 | synchronous rectifier. Connect 100nF capacitor to AC1/AC2 separately                             |
| H1,H2,H3             | AC1      | I | AC power input of synchronous restifier  |
| H4,H5,H6             | AC2      | Ι | AC power input of synchronous rectifier.   |
| J1,J2,J3,J4<br>J5,J6 | PGND     | Ρ | Power ground for synchronous rectifier.  |



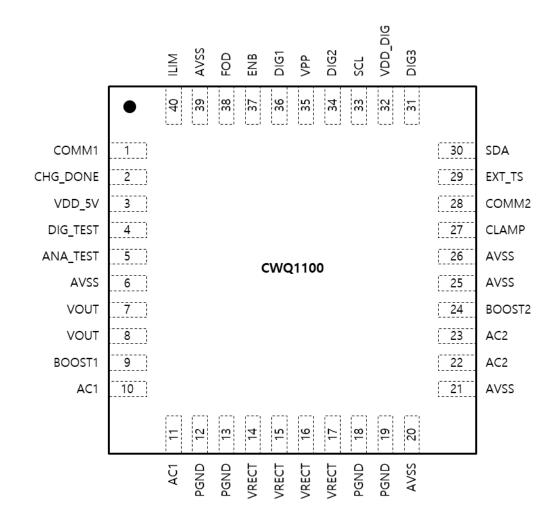


Figure 3. CWQ1100 Pin Configuration (QFN 40-pin 6mm x 6mm, 0.5mm pitch)

### 2.2 Pin Description (QFN 40-pin 6mm x 6mm, 0.5mm pitch)

| Pin Number          | Name     | Туре | Description  |
|---------------------|----------|------|--|
| 1                   | COMM1    | 0    | High voltage open drain output for ASK modulation. Connect 47nF capacitor                        |
| 28                  | COMM2    | 0    | from AC1/AC2 to COMM1/COMM2 separately   |
| 2                   | CHG_DONE | Ι    | Active-high input from the external battery charger to terminate power transfer.                 |
| 3                   | VDD_5V   | Р    | Internal 5V LDO output pin for 1uF capacitor connection, not for external use                    |
| 4                   | DIG_TEST | 0    | Digital test output pin. Floating for normal application   |
| 5                   | ANA_TEST | 0    | Analog test output pin. Floating for normal application  |
| 6,20,21,25<br>26,39 | AVSS     | Ρ    | Analog ground pin.   |
| 7,8                 | VOUT     | Р    | Main LDO output pin for delivering power to the battery charger, 3.3uF capacitor connect to GND. |

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| 9           | BOOST1  | 0   | Bootstrap capacitor connection pin for driving the high-side FETs of  |
|-------------|---------|-----|---|
| 24          | BOOST2  | 0   | synchronous rectifier. Connect 100nF capacitor to AC1/AC2 separately  |
| 10,11       | AC1     | I   | AC power input of synchronous rectifier.  |
| 22,23       | AC2     | I   | Ac power input of synchronous rectifier.  |
| 12,13,18,19 | PGND    | Р   | Power ground for synchronous rectifier.   |
| 14,15,16,17 | VRECT   | Р   | Internal synchronous rectifier output for 20uF capacitor connection.  |
| 27          | CLAMP   | 0   | High voltage open drain output for analog linear over-voltage protection.   |
| 29          | EXT_TS  | I   | External temperature sensor input. Connect this pin to external NTC thermistor. If not used, connect this pin to VDD_DIG. |
| 30          | SDA     | 1/0 | I <sup>2</sup> C data input/output for internal register access.  |
| 31          | DIG3    | I   | Scan clock for scan test mode. Connect to GND directly in normal application.   |
| 32          | VDD_DIG | Р   | Internal 3V LDO output for digital block and etc.1uF capacitor connect to GND.<br>Not for external use                    |
| 33          | SCL     | I   | I <sup>2</sup> C clock input for internal register access.  |
| 34          | DIG2    | I   | Scan enable for scan test mode. Connect to GND directly in normal application.  |
| 35          | VPP     | I   | 8V high voltage power for OTP programming. During the normal operation, connect this pin to VDD_DIG.                      |
| 36          | DIG1    | I   | Enable scan test mode. Connect to GND directly in normal application.   |
| 37          | ENB     | I   | Active-low enable pin for the entire chip.  |
| 38          | FOD     | I   | FOD offset setting pin. Connect a resistor between this pin and GND.  |
| 40          | ILIM    | I   | Output current or over-current limit level programming pin.   |



# 3. Application Guide

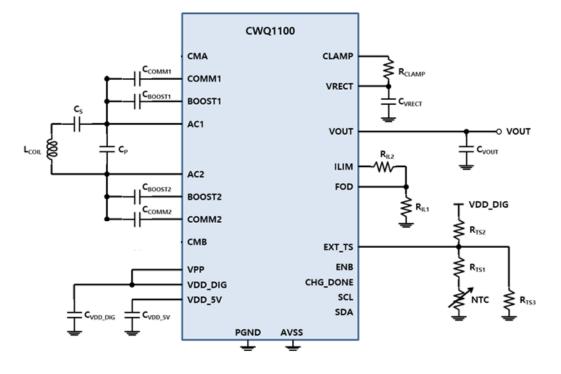


Figure 4. CWQ1100 Typical Application Diagram

### 3.1 Receiver Coil and Resonant Capacitors

The receiver coil design is related to the overall system application. The coil inductance, shape and material can be chosen according to the applications. The recommended receiver coil inductance for dual mode operation is between 5uH to 10uH. Series and parallel resonant capacitors  $C_s$  and  $C_d$  are set according to WPC specification. The capacitance of the resonant capacitors can be calculated by the following equations.

$$\begin{split} C_{S} &= \frac{1}{L'_{S} \times (2\pi f_{S})^{2}} \\ C_{d} &= \frac{1}{L_{S} \times (2\pi f_{D})^{2} - \frac{1}{C_{S}}} \end{split}$$

In these equations,  $f_s$  and  $f_D$  are the dual resonant frequencies which cover the power transfer frequency range. Follow WPC Qi 1.2.4 specifications,  $f_s$  is set to 100 kHz and  $f_D$  is set to 1000kHz, respectively. L's is coil self-inductance when placed on the transmitter, and  $L_s$  is the self-inductance when placed away from the transmitter.

### 3.2 Boost and Communication Capacitors

As shown in Figure 4, two external bootstrap capacitors  $C_{BOOST1}$  and  $C_{BOOST2}$  are needed to drive the highside FETs of synchronous rectifier. Bootstrap capacitors should have voltage rating of more than 25V and their recommended capacitances are 100nF.

In order to communicate with transmitter, external capacitors should be connected between high voltage open drain output and AC1/AC2 input. CWQ1100 will be switching COMM1/COMM2 output in WPC mode. Typical recommended capacitance values are  $C_{COMM1}=C_{COMM2}=47$ nF.



#### 3.3 Output Regulating Capacitors

As shown in Figure 4, rectifier output VRECT and internal LDOs' output VOUT, VDD\_5V, VDD\_DIG should be connected to external capacitor for voltage regulation. Typical recommended capacitance values are  $C_{VRECT}$ =20uF,  $C_{VOUT}$ =3.3uF,  $C_{VDD_5V}$ =1uF,  $C_{VDD_DIG}$ =1uF, respectively.

### 3.4 Clamp Resistor

When the VRECT voltage is too high, the OVP (Over Voltage Protection) function will turn on the clamp path or send the EPT (End Power Transfer) packet to the transmitter. The clamp path uses high voltage open drain output for analog linear OVP. The recommended resistance value of  $R_{CLAMP}$  is between  $10\Omega$  to  $50\Omega$  according to the transfer power level of application.

#### 3.5 Current Limit and FOD Setting Resistors

When the main LDO current is too large, the OCL (Over Current Limit) function will limit the output current. The current limit level can be adjusted by external resistors and it is calculated as follows,

$$I_{LIM} = \frac{45000}{R_{ILIM}} = \frac{45000}{R_{IL1} + R_{IL2}}$$

In this equation, the  $R_{ILIM}$  is the total resistance from the ILIM pin to ground, that is,  $R_{IL1} + R_{IL2}$  as shown in Figure 4. It is recommended to use the resistors of good tolerance less than 1%, because the current estimation in wireless power receiver is very important.

CWQ1100 adds an FOD offset proportional to output power level when it sends the received power packet to transmitter. The amount of the added FOD offset can be adjusted by the ratio of  $R_{IL1}$  to  $(R_{IL1} + R_{IL2})$ .

#### 3.6 External Temperature Sensor

When the temperature inside or outside the chip is too high, the OTP (Over Temperature Protection) function will send the EPT packet to transmitter or shutdown the receiver system. In order to sense the temperature outside chip, connect EXT\_TS pin to external NTC (Negative temperature Coefficient) thermistor as shown in Figure 4. The NTC thermistor should be placed close to the heat emission device. The EXT\_TS voltage  $V_{EXT}$  can be calculated as follows,

 $V_{EXT_{TS}} = VDD_DIG \times \frac{\frac{(R_{NTC} + R_{TS1}) \times R_{TS3}}{(R_{NTC} + R_{TS1}) + R_{TS3}}}{\frac{(R_{NTC} + R_{TS1}) \times R_{TS3}}{(R_{NTC} + R_{TS1}) + R_{TS3}} + R_{TS2}}$ 

In this equation, VDD\_DIG is 3V from the internal LDO.

CWQ1100 compares  $V_{EXT_TS}$  with internal reference voltages  $V_{TS_HOT}$  and  $V_{TS_COLD}$ . If  $V_{EXT_TS} < V_{TS_HOT}$ , it means external temperature is too high and CWQ1100 sends the EPT packet (value=0x03) to transmitter. On the other hand, if  $V_{EXT_TS} > V_{TS_COLD}$ , it means external temperature is too low and CWQ1100 also sends the EPT packet (value=0x03) to transmitter. Remind that  $V_{EXT_TS}$  is negative slope curve vs temperature.

The internal reference voltages  $V_{TS\_HOT}$  and  $V_{TS\_COLD}$  are fixed values as follows,

| Internal TS Reference | Threshold Voltage [V] | Hysteresis [mV] |
|-----------------------|-----------------------|-----------------|
| V <sub>TS_HOT</sub>   | 0.315                 | 20              |
| V <sub>TS_COLD</sub>  | 0.980                 | 80              |



Recommended NTC resistance range is from hundreds of  $\Omega$  to hundreds of  $k\Omega$  vs temperature. After choosing the appropriate NTC thermistor, you can design R<sub>TS1</sub>, R<sub>TS2</sub> and R<sub>TS3</sub> according to your thermal protection specification. Table 1 shows an EXT\_TS thermal protection design example.

| Temp<br>[℃] | VDD_DIG<br>[V] | R <sub>ΝΤC</sub><br>[kΩ] | R <sub>TS1</sub><br>[kΩ] | R <sub>TS2</sub><br>[kΩ] | R <sub>TS3</sub><br>[kΩ] | V <sub>EXT_TS</sub><br>[V] | Status   |
|-------------|----------------|--------------------------|--------------------------|--------------------------|--------------------------|----------------------------|--|
| -40         | 3.0            | 188.5                    | 3.9                      | 47                       | 68                       | 1.550                      |  |
| -30         | 3.0            | 111.3                    | 3.9                      | 47                       | 68                       | 1.429                      | V <sub>EXT_TS</sub> > V <sub>TS_COLD</sub>                       |
| -20         | 3.0            | 67.8                     | 3.9                      | 47                       | 68                       | 1.278                      | Send EPT packet  |
| -10         | 3.0            | 42.5                     | 3.9                      | 47                       | 68                       | 1.109                      |  |
| 0           | 3.0            | 27.3                     | 3.9                      | 47                       | 68                       | 0.938                      |  |
| 10          | 3.0            | 18.0                     | 3.9                      | 47                       | 68                       | 0.782                      |  |
| 20          | 3.0            | 12.1                     | 3.9                      | 47                       | 68                       | 0.648                      |  |
| 30          | 3.0            | 8.31                     | 3.9                      | 47                       | 68                       | 0.541                      | V <sub>TS_HOT</sub> < V <sub>EXT_TS</sub> < V <sub>TS_COLD</sub> |
| 40          | 3.0            | 5.83                     | 3.9                      | 47                       | 68                       | 0.460                      | Normal charging operation  |
| 50          | 3.0            | 4.16                     | 3.9                      | 47                       | 68                       | 0.399                      |  |
| 60          | 3.0            | 3.02                     | 3.9                      | 47                       | 68                       | 0.354                      |  |
| 70          | 3.0            | 2.23                     | 3.9                      | 47                       | 68                       | 0.321                      |  |
| 80          | 3.0            | 1.67                     | 3.9                      | 47                       | 68                       | 0.296                      |  |
| 90          | 3.0            | 1.27                     | 3.9                      | 47                       | 68                       | 0.278                      |  |
| 100         | 3.0            | 0.98                     | 3.9                      | 47                       | 68                       | 0.265                      | V <sub>EXT_TS</sub> < V <sub>TS_HOT</sub><br>Send EPT packet     |
| 110         | 3.0            | 0.76                     | 3.9                      | 47                       | 68                       | 0.255                      | '  |
| 120         | 3.0            | 0.60                     | 3.9                      | 47                       | 68                       | 0.247                      |  |

#### Table 1. EXT\_TS Thermal Protection Design Example

In this example, the hot temperature threshold  $T_{TS\_HOT}$  and the cold temperature threshold  $T_{TS\_COLD}$  are designed to be 80°C and -10°C respectively. You can change the hot and cold temperature threshold according to your application by changing the related resistors.

### 3.7 CHG\_DOWN

When CHG\_DOWN is from low to high, CWQ1100 send "charging complete" EPT (0x01) to TX to inform TX that battery is charging complete.

#### 3.8 ENB

When applying logic high to ENB, CWQ1100 is suspended and IC leakage current will be smaller than 10uA. When ENB is logic low level, CWQ1100 is enabled for wireless charging.

### 3.9 PCB Layout Guide

- Keep the trace resistance as low as possible on large current nets as shown in Table 2.
- Resonant capacitors C<sub>s</sub> and C<sub>d</sub> need to be as close to the device as possible.
- Clamp, boost and communication capacitors (C<sub>CLAMP</sub>, C<sub>BOOST1</sub>, C<sub>BOOST2</sub>, C<sub>COMM1</sub>, C<sub>COMM2</sub>, C<sub>CMA</sub> and C<sub>CMB</sub>) need to be as close to the device as possible.



- Output regulating capacitors C<sub>VRECT</sub> and C<sub>VOUT</sub> need to be as close to the device as possible.
- LDO capacitors C

| Net (Ball)             | Туре | Maximum Current [A] |
|------------------------|------|---------------------|
| AC1, AC2               | AC   | 2                   |
| VRECT                  | AC   | 2                   |
| VOUT                   | DC   | 2                   |
| PGND                   | AC   | 2                   |
| COMM1, COMM2, CMA, CMB | AC   | 1                   |
| CLAMP                  | AC   | 2                   |

#### Table 2. Large Current Nets

#### 3.10 Register Map

#### 7bit Address: 0x24H.

| Register<br>index |                        |          |                   | Bit       | Number        |              |          |           |     |
|-------------------|------------------------|----------|-------------------|-----------|---------------|--------------|----------|-----------|-----|
| (hex)             | B7                     | B6       | B5 B4 B3 B2 B1 B0 |           |               |              |          |           | W/R |
| 27h               | SET_VOUT_EXTENDED[3:0] |          |                   |           | SET_VOUT      | _BASE_LINE[3 | :0]      | W/R       |     |
| 2Eh               | COLD_U                 | JTP[1:0] | TSD               | [1:0]     | OVP[          | 1:0]         | HOT      | _OTP[1:0] | W/R |
|                   |                        | OCL_ON_  |                   |           | TSD_OUT_      | OVP_OU       | OTP_HOT_ | OTP_COLD_ |     |
| 2Fh               | PEN_PROT               | MASK     | RELEASE           | TIME[1:0] | MASK          | T_MASK       | MASK     | MASK      | W/R |
| 41h               |                        |          |                   | REF_0     | Q_FACTOR      |              |          |           | W/R |
| 42h               |                        |          |                   | PTC_GUA   | RANTEED_PWI   | R            |          |           | R   |
| 5Ch               |                        |          |                   | AD        | C_CODE        |              |          |           | W/R |
| 5Dh               |                        | Reserv   | /ed               |           | ADC_OUT[11:8] |              |          |           | R   |
| 5Eh               |                        |          |                   | ADC_      | _OUT[7:0]     |              |          |           | R   |
| 62h               |                        |          |                   | 8b        | oit RP        |              |          |           | R   |
| 63h               |                        |          |                   | 24bit     | RP[15:8]      |              |          |           | R   |
| 64h               |                        |          |                   | 24bi      | t RP[7:0]     |              |          |           | R   |
| 68h               | POWER                  | _CLASS   |                   |           | GUARANTEE     | D_POWER_\    | ALUE     |           | R   |
| 69h               | Rese                   | rved     |                   |           | POTENTIAL     | _POWER_VA    | LUE      |           | R   |



#### DETAILED REGISTER INFORMATION

| REG | Bit | Field           | Туре   | Default | Description  |
|-----|-----|-----------------|--------|---------|--|
|     | 7   | VOUT_EPP[3]     | R/W    | 1       |  |
|     | 6   | VOUT_EPP[2]     | R/W    | 0       | Setup bits of VOUT voltage for extended profile ,O   |
|     | 5   | VOUT_EPP[1]     | R/W    | 0       | ffset: 4.5 V, Range 4.5 V – 12 V; Unit=0.5V  |
|     | 4   | VOUT_EPP[0]     | R/W    | 1       | Default: 9 V (1001)  |
| 27H | 3   | VOUT_BPP[3]     | R/W    | 0       | Setup bits of VOUT voltage for base line profile   |
|     | 2   | VOUT_BPP[2]     | R/W    | 0       | Offset: 4.5 V, Range 4.5 V – 12 V; Unit=0.5V   |
|     | 1   | VOUT_BPP[1]     | R/W    | 0       | Default: 5 V (0001).   |
|     | 0   | VOUT_BPP[0]     | R/W    | 1       | Normal case, VOUT=5V in BPP mode   |
| REG | Bit | Field           | Туре   | Default | Description  |
|     | 7   | COLD_UTP[1]     | R/W    | 1       | 00 1.163V / 1.073V (Detection / Release)   |
|     | 1   |                 |        | I       | 01 1.069V / 0.984V (Detection / Release)   |
|     | 6   | COLD_UTP[0]     | R/W    | 0       | 10 0.980V / 0.898V (Detection / Release)   |
|     | 0   |                 |        | 0       | 11 0.894V / 0.820V (Detection / Release)   |
|     | 5   |                 | R/W    | 1       | 00 130 ℃ / 110 ℃ (Die OTP Detection / Release)   |
|     | 5   | TSD[1]          |        | I       | 01 140 °C / 120 °C (Die OTP Detection / Release)   |
|     | 4   | TSD[0]          | R/W    | 0       | 10 150 °C / 130 °C (Die OTP Detection / Release)   |
| 2EH | 4   | 130[0]          | Γ./ VV | 0       | 11 160 °C / 140 °C (Die OTP Detection / Release)   |
| 201 | 3   |                 |        | 1       | 00 14.0 V / 12.5 V (Detection / Release)   |
|     | 0   | OVP[1]          | R/W    | 1       | 01 14.5 V / 13.0 V (Detection / Release)   |
|     | 2   | OVP[0]          | R/W    | 0       | 10 15.0 V / 13.5 V (Detection / Release)   |
|     | 2   |                 |        | 0       | 11 15.5 V / 14.0 V (Detection / Release)   |
|     | 1   | HOT_OTP[1]      | R/W    | 1       | 00 0.339V / 0.367V (Detection / Release)   |
|     | 1   |                 |        | I       | 01 0.326V / 0.351V (Detection / Release)   |
|     | 0   | HOT_OTP[0]      | R/W    | 0       | 10 0.314V / 0.335V (Detection / Release)   |
|     | 0   |                 |        | 0       | 11 0.306V / 0.322V (Detection / Release)   |
| REG | Bit | Field           | Туре   | Default | Description  |
|     | 7   | PEN_PROT        | R/W    | 1       | 0:disable protection function,<br>1:enable protection function                                     |
|     | 6   | OCL_ON_MASK     | R/W    | 1       | 0: No mask; 1: mask  |
|     | 5   | RELEASE_TIME[1] | R/W    | 0       | Initially all signals are masked and release masks after   |
| 2FH | 4   | RELEASE_TIME[0] | R/W    | 0       | a time delay. 00:No release; 01: Release after 5s;<br>10: Release after 10s; 11:Release after 20s; |
|     | 3   | TSD_OUT_MASK    | R/W    | 1       | 0: No mask; 1: mask  |
|     | 2   | OVP_OUT_MASK    | R/W    | 1       | 0: No mask; 1: mask  |
|     | 1   | OTP_HOT_MASK    | R/W    | 1       | 0: No mask; 1: mask  |
|     | 0   | OTP_COLD_MASK   | R/W    | 1       | 0: No mask; 1: mask  |



| REG        | Bit  | Field  | Туре  | Default   | Description   |  |
|------------|--|--|---|---|---|--|
|            | 7  | REF_Q_FACTOR[7]  | R/W   | 0   |   |  |
|            | 6  | REF_Q_FACTOR[6]  | R/W   | 0   |   |  |
|            | 5  | REF_Q_FACTOR[5]  | R/W   | 0   |   |  |
|            | 4  | REF_Q_FACTOR[4]  | R/W   | 1   |   |  |
| 41H        | 3  | REF_Q_FACTOR[3]  | R/W   | 0   | Quality factor reference value  |  |
|            | 2  | REF_Q_FACTOR[2]  | R/W   | 1   |   |  |
|            | 1  | REF_Q_FACTOR[1]  | R/W   | 0   |   |  |
|            | 0  | REF_Q_FACTOR[0]  | R/W   | 0   |   |  |
| REG        | Bit  | Field  | Туре  | Default   | Description   |  |
|            | 7  | Reserved   | -   | -   | Reserved  |  |
|            | 6  | Reserved   | -   | -   | Reserveu  |  |
|            | 5  | PTC_GUARANTEED_PO<br>WER[5]  | R   | 0   |   |  |
|            | 4  | PTC_GUARANTEED_PO<br>WER[4]  | R   | 0   |   |  |
| 42H        | 3  | PTC_GUARANTEED_PO<br>WER[3]  | R   | 1   | Guaranteed Power Value in Power Transfer  |  |
|            | 2  | PTC_GUARANTEED_PO<br>WER[2]  | R   | 0   | Contract. Unit=0.5W   |  |
|            | 1  | PTC_GUARANTEED_PO<br>WER[1]  | R   | 1   |   |  |
|            | 0  | PTC_GUARANTEED_PO<br>WER[0]  | R   | 0   |   |  |
| REG        | Bit  | Field  | Туре  | Default   | Description   |  |
|            | 7  | Reserved   | -   | -   |   |  |
|            | 6  | Reserved   | -   | -   | Reserved  |  |
|            | 5  | Reserved   | -   | -   |   |  |
|            | -  |  |   |   |   |  |
| 5CH        | 4  | Reserved   | -   | -   |   |  |
| 5CH        |  | Reserved<br>ADC_CODE[3]  | -<br>R/W                                    | -<br>0  | The related ADC_OUT value is loaded to<br>Reg: 0x5D and Reg 0x5E  |  |
| 5CH        | 4  |  | -<br>R/W<br>R/W                             | -<br>0<br>0                                     | Reg: 0x5D and Reg 0x5E.<br>4'b0000:VRECT; 4'0001:VOUT   |  |
| 5CH        | 4<br>3   | ADC_CODE[3]  | -   | _   | Reg: 0x5D and Reg 0x5E.<br>4'b0000:VRECT; 4'0001:VOUT<br>4'b0010:IOUT; 4'b0011:ILIM   |  |
| 5CH        | 4<br>3<br>2  | ADC_CODE[3]<br>ADC_CODE[2]   | R/W   | 0 0 0 0   | Reg: 0x5D and Reg 0x5E.<br>4'b0000:VRECT; 4'0001:VOUT   |  |
| 5CH<br>REG | 4<br>3<br>2<br>1   | ADC_CODE[3]<br>ADC_CODE[2]<br>ADC_CODE[1]  | R/W<br>R/W                                  | 0   | Reg: 0x5D and Reg 0x5E.<br>4'b0000:VRECT; 4'0001:VOUT<br>4'b0010:IOUT; 4'b0011:ILIM<br>4'b0100:FOD; 4'b0101: EXT_TS   |  |
|            | 4<br>3<br>2<br>1<br>0  | ADC_CODE[3]<br>ADC_CODE[2]<br>ADC_CODE[1]<br>ADC_CODE[0]<br>Field<br>Reserved  | R/W<br>R/W<br>R/W                           | 0 0 0 0   | Reg: 0x5D and Reg 0x5E.<br>4'b0000:VRECT; 4'0001:VOUT<br>4'b0010:IOUT; 4'b0011:ILIM<br>4'b0100:FOD; 4'b0101: EXT_TS<br>4'b0110:VCTAT  |  |
|            | 4<br>3<br>2<br>1<br>0<br><b>Bit</b>                          | ADC_CODE[3]<br>ADC_CODE[2]<br>ADC_CODE[1]<br>ADC_CODE[0]<br>Field  | R/W<br>R/W<br>R/W                           | 0 0 0 0   | Reg: 0x5D and Reg 0x5E.         4'b0000:VRECT;       4'0001:VOUT         4'b010:IOUT;       4'b0011:ILIM         4'b0100:FOD;       4'b0101: EXT_TS         4'b0110:VCTAT       Description   |  |
|            | 4<br>3<br>2<br>1<br>0<br><b>Bit</b><br>7                     | ADC_CODE[3]<br>ADC_CODE[2]<br>ADC_CODE[1]<br>ADC_CODE[0]<br>Field<br>Reserved<br>Reserved<br>Reserved                            | R/W<br>R/W<br>R/W                           | 0<br>0<br>0<br>Default<br>-                     | Reg: 0x5D and Reg 0x5E.<br>4'b0000:VRECT; 4'0001:VOUT<br>4'b0010:IOUT; 4'b0011:ILIM<br>4'b0100:FOD; 4'b0101: EXT_TS<br>4'b0110:VCTAT  |  |
| REG        | 4<br>3<br>2<br>1<br>0<br><b>Bit</b><br>7<br>6                | ADC_CODE[3]<br>ADC_CODE[2]<br>ADC_CODE[1]<br>ADC_CODE[0]<br>Field<br>Reserved<br>Reserved  | R/W<br>R/W<br>R/W<br><b>Type</b><br>-<br>-  | 0<br>0<br>0<br>Default<br>-                     | Reg: 0x5D and Reg 0x5E.         4'b0000:VRECT;       4'0001:VOUT         4'b010:IOUT;       4'b0011:ILIM         4'b0100:FOD;       4'b0101: EXT_TS         4'b0110:VCTAT       Description   |  |
|            | 4<br>3<br>2<br>1<br>0<br><b>Bit</b><br>7<br>6<br>5           | ADC_CODE[3]<br>ADC_CODE[2]<br>ADC_CODE[1]<br>ADC_CODE[0]<br>Field<br>Reserved<br>Reserved<br>Reserved                            | R/W<br>R/W<br>R/W<br>-<br>-<br>-            | 0<br>0<br>0<br>Default<br>-<br>-                | Reg: 0x5D and Reg 0x5E.         4'b0000:VRECT;       4'0001:VOUT         4'b010:IOUT;       4'b0101:ILIM         4'b0100:FOD;       4'b0101: EXT_TS         4'b0110:VCTAT       Description         Reserved         ADC value with Reg 5EH according to  |  |
| REG        | 4<br>3<br>2<br>1<br>0<br><b>Bit</b><br>7<br>6<br>5<br>4      | ADC_CODE[3]<br>ADC_CODE[2]<br>ADC_CODE[1]<br>ADC_CODE[0]<br>Field<br>Reserved<br>Reserved<br>Reserved<br>Reserved                | R/W<br>R/W<br>R/W<br>-<br>-<br>-<br>-<br>-  | 0<br>0<br>0<br>Default<br>-<br>-<br>-<br>-      | Reg: 0x5D and Reg 0x5E.         4'b0000:VRECT;       4'0001:VOUT         4'b010:IOUT;       4'b0101:ILIM         4'b0100:FOD;       4'b0101: EXT_TS         4'b0110:VCTAT       Description         Reserved  |  |
| REG        | 4<br>3<br>2<br>1<br>0<br><b>Bit</b><br>7<br>6<br>5<br>4<br>3 | ADC_CODE[3]<br>ADC_CODE[2]<br>ADC_CODE[1]<br>ADC_CODE[0]<br>Field<br>Reserved<br>Reserved<br>Reserved<br>Reserved<br>ADC_OUT[11] | R/W<br>R/W<br>Type<br>-<br>-<br>-<br>-<br>R | 0<br>0<br>0<br>Default<br>-<br>-<br>-<br>-<br>0 | Reg: 0x5D and Reg 0x5E.         4'b0000:VRECT;       4'0001:VOUT         4'b010:IOUT;       4'b0101:ILIM         4'b0100:FOD;       4'b0101: EXT_TS         4'b0110:VCTAT       Description         Reserved         ADC value with Reg 5EH according to         ADC_CODE register select ADC channel |  |



| REG | Bit    | Field         | Туре   | Default | Description   |
|-----|--------|---------------|--------|---------|---|
|     | 7      | ADC_OUT[7]    | R      | 0       |   |
|     | 6      | ADC_OUT[6]    | R      | 0       |   |
|     | 5      | ADC_OUT[5]    | R      | 0       |   |
| 5EH | 4      | ADC_OUT[4]    | R      | 0       | ADC value with Reg5DH according to                    |
| 5EH | 3      | ADC_OUT[3]    | R      | 0       | ADC_COUD register select ADC<br>channel ADC LSB 8bits |
|     | 2      | ADC_OUT[2]    | R      | 0       |   |
|     | 1      | ADC_OUT[1]    | R      | 0       |   |
|     | 0      | ADC_OUT[0]    | R      | 0       |   |
| REG | Bit    | Field         | Туре   | Default | Description   |
|     | 7      | 8bit RP[7]    | R      | 0       |   |
|     | 6      | 8bit RP[6]    | R      | 0       |   |
|     | 5      | 8bit RP[5]    | R      | 0       |   |
| 62H | 4      | 8bit RP[4]    | R      | 0       | 8bits Receiver Power Package Value-                   |
|     | 3      | 8bit RP[3]    | R      | 0       | BPP only  |
|     | 2      | 8bit RP[2]    | R      | 0       |   |
|     | 1      | 8bit RP[1]    | R      | 0       |   |
|     | 0      | 8bit RP[0]    | R      | 0       |   |
| REG | Bit    | Field         | Туре   | Default | Description   |
|     | 7      | 24bit RP[15]  | R      | 0       |   |
|     | 6      | 24bit RP[14]  | R      | 0       |   |
|     | 5      | 24bit RP[13]  | R      | 0       |   |
| 63H | 4      | 24bit RP[12]  | R      | 0       | 24bits Receiver Power Package Value                   |
|     | 3      | 24bit RP[11]  | R      | 0       | High 8bits-EPP only                                   |
|     | 2      | 24bit RP[10]  | R      | 0       |   |
|     | 1      | 24bit RP[9]   | R      | 0       |   |
|     | 0      | 24bit RP[8]   | R      | 0       |   |
| REG | Bit    | Field         | Туре   | Default | Description   |
|     | 7      | 24bit RP[7]   | R      | 0       |   |
|     | 6      | 24bit RP[6]   | R      | 0       |   |
|     | 5      | 24bit RP[5]   | R      | 0       |   |
|     | 4      | 24bit RP[4]   | R      | 0       | 24bits Receiver Power Package Value                   |
| 64H |        | 24bit RP[3]   | R      | 0       | Low 8bits-EPP only                                    |
|     | 3      | 24bit TCF [5] |        |         |   |
|     | 3<br>2 | 24bit RP[2]   | R      | 0       |   |
|     |        |               | R<br>R | 0       |   |



| REG        | Bit                   | Field   | Туре                  | Default                | Description                      |
|------------|-----------------------|---|-----------------------|------------------------|----------------------------------|
|            | 7                     | TX POWER CLASS[1]   | R                     | 0                      | TV Dower Class Value by ESK      |
|            | 6                     | TX POWER CLASS[0]   | R                     | 0                      | TX Power Class Value by FSK      |
|            | 5                     | TX_GUARANTEED_POWER[5]  | R                     | 0                      |                                  |
| 68H        | 4                     | TX_GUARANTEED_POWER[4]  | R                     | 0                      |                                  |
| 001        | 3                     | TX_GUARANTEED_POWER[3]  | R                     | 0                      | TX Guaranteed Power Value by FSK |
|            | 2                     | TX_GUARANTEED_POWER[2]  | R                     | 0                      | TX Guaranteed Power Value by FSK |
|            | 1                     | TX_GUARANTEED_POWER[1]  | R                     | 0                      |                                  |
|            | 0                     | TX_GUARANTEED_POWER[0]  | R                     | 0                      |                                  |
|            |                       |   |                       |                        |                                  |
| REG        | Bit                   | Field   | Туре                  | Default                | Description                      |
| REG        | Bit<br>7              | Field<br>Reserved   | Type<br>-             | Default<br>-           |                                  |
| REG        |                       |   | Туре<br>-<br>-        | Default<br>-<br>-      | Description                      |
| REG        | 7                     | Reserved  | Type<br>-<br>-<br>R   | Default<br>-<br>-<br>0 |                                  |
|            | 7 6                   | Reserved  | -                     | -                      |                                  |
| REG<br>69H | 7<br>6<br>5           | Reserved<br>Reserved<br>TX_POTENTIAL_POWER[5]   | -<br>-<br>R           | -<br>-<br>0            | Reserved                         |
|            | 7<br>6<br>5<br>4      | Reserved<br>Reserved<br>TX_POTENTIAL_POWER[5]<br>TX_POTENTIAL_POWER[4]                          | -<br>-<br>R<br>R      | -<br>-<br>0<br>0       |                                  |
|            | 7<br>6<br>5<br>4<br>3 | Reserved<br>Reserved<br>TX_POTENTIAL_POWER[5]<br>TX_POTENTIAL_POWER[4]<br>TX_POTENTIAL_POWER[3] | -<br>-<br>R<br>R<br>R | -<br>-<br>0<br>0<br>0  | Reserved                         |



# 4. Package Outline

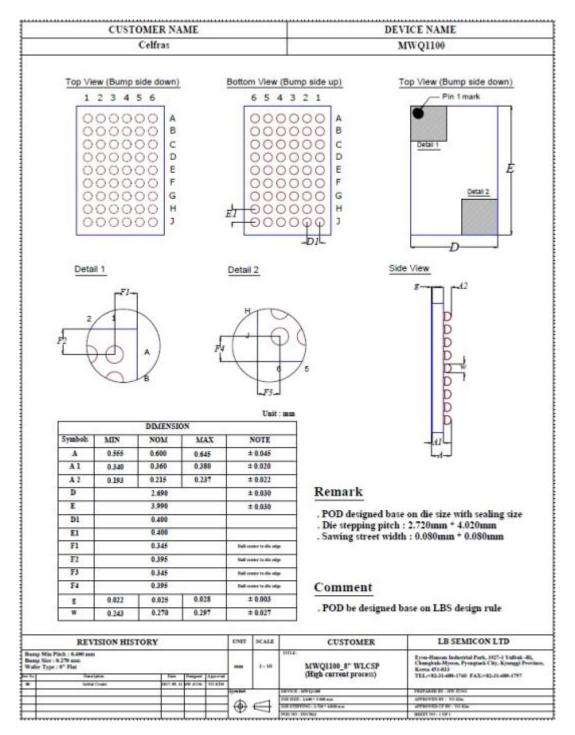


Figure 5. WLCSP 50B Package Outline, 2.64mm x 3.94mm, 0.4mm pitch



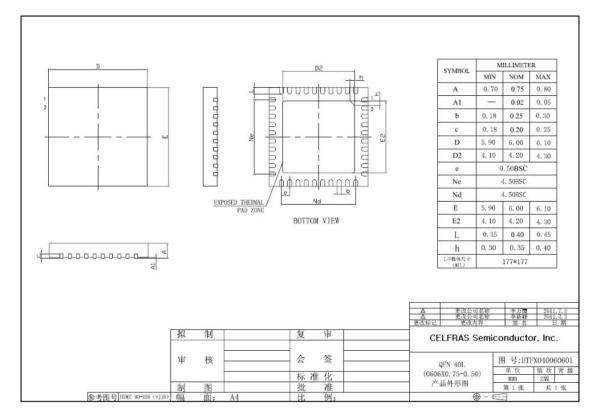


Figure 6. QFN 40-pin Package Outline, 6.0mm x 6.0mm, 0.5mm pitch



# 5. Electrical Characteristics

### 5.1 Absolute Maximum Rating

| PIN   | Parameter   | Rating      | Unit |
|---|-------------|-------------|------|
| AC1, AC2, COMM1, COMM2, CMA, CMB<br>VRECT, CLAMP              | Voltage     | -0.3 to 20  | v    |
| BOOST1, BOOST2  | Voltage     | -0.3 to 26  | ۷    |
| VOUT  | Voltage     | -0.3 to 15  | ۷    |
| VPP   | Voltage     | -0.3 to 8   | V    |
| VDD_5V, VDD_DIG, ENB, CHG_DONE<br>ILIM, FOD, EXT_TS, SCL, SDA | Voltage     | -0.3 to 6   | v    |
| PGND  | Voltage     | -0.3 to 0.3 | ۷    |
| AC1, AC2, VRECT, VOUT, CLAMP, PGND                            | Current     | 2           | А    |
| COMM1, COMM2, CMA, CMB  | RMS Current | 1           | А    |

### 5.2 Recommended Operating Condition

| Symbol            | Description               | Min. | Тур. | Max. | Unit |
|-------------------|---------------------------|------|------|------|------|
| V <sub>RECT</sub> | Rectifier voltage range   | 4    |      | 15   | V    |
| lout              | Main LDO output current   |      |      | 2    | А    |
| Ісомм             | COMM1, COMM2 sink current |      |      | 500  | mA   |
| Ісм               | CMA, CMB sink current     |      |      | 500  | mA   |
| TJ                | Junction temperature      | -30  |      | 125  | °C   |
| T <sub>A</sub>    | Ambient temperature       | -30  |      | 85   | °C   |

#### 5.3 Thermal Information

| Parameters                              | CWQ1100 WLCSP 50B<br>2.64mm x 3.94mm | UNITS |
|---|--------------------------------------|-------|
| Junction-to-ambient thermal resistance  |                                      | °C/W  |
| Junction-to-case thermal resistance     |                                      | °C/W  |
| Junction-to-board thermal resistance    |                                      | °C/W  |
| Junction temperature , TJ               |                                      | °C    |
| Ambient operation temperature           |                                      | °C    |
| Storage temperature, T <sub>stg</sub>   |                                      | °C    |
| Lead soldering temperature , $T_L(10s)$ |                                      | °C    |



| Parameters QF                          | CWQ1100<br>N40 6mm x 6mm | UNITS |
|--|--------------------------|-------|
| Junction-to-ambient thermal resistance |                          | °C/W  |
| Junction-to-case thermal resistance    |                          | °C/W  |
| Junction-to-board thermal resistance   |                          | °C/W  |
| Junction temperature , T <sub>J</sub>  |                          | °C    |
| Ambient operation temperature          |                          | °C    |
| Storage temperature , T <sub>stg</sub> |                          | °C    |
| Lead soldering temperature , TL(10s)   |                          | °C    |

#### 5.4 ESD

| Test Model    | RATINGS | UNITS |
|---------------|---------|-------|
| HBM: all pins |         | V     |
| CDM: all pins |         | V     |

### 5.5 ELECTRICAL Characteristics

### Unless otherwise specified: $T_A = -20^{\circ}C$ to 70°C. Typical values are for $T_A = 25^{\circ}C$

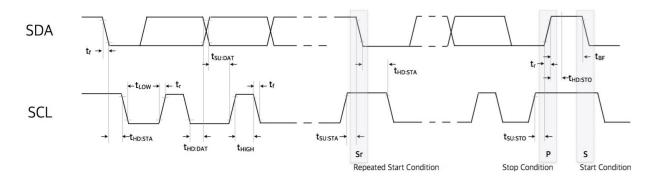
| Symbol                         | Description  | Conditions  | Min. | Тур. | Max. | Unit |
|--------------------------------|--|---|------|------|------|------|
| Synchronous A                  | ctive Rectifier  |   |      |      |      |      |
| $V_{\text{IN}_{\text{RECT}}}$  | AC1, AC2 input voltage range                           |   | 4.0  |      | 20   | V    |
| f <sub>IN_RECT</sub>           | AC1, AC2 input frequency range                         |   | 80   |      | 500  | kHz  |
| E <sub>ff_RECT</sub>           | AC to DC power conversion efficiency                   |   |      | 92   |      | %    |
| V <sub>UVLO</sub>              | Under voltage lockout                                  | V <sub>RECT</sub> : 0V to 4V  |      | 3.2  | 3.3  | V    |
| $V_{\text{UVLO}_{\text{HYS}}}$ | Under voltage lockout hysteresis                       | V <sub>RECT</sub> : 4V to 0V  |      | 400  |      | mV   |
| Main LDO                       |  |   |      |      |      |      |
| VIN_MLDO                       | Main LDO input voltage range                           |   | 4.0  |      | 15   | v    |
| V <sub>OUT_MLDO</sub>          | Main LDO output voltage range<br>Register programmable | V <sub>RECT</sub> >5V   | 4.5  |      | 12   | v    |
| VOUT_MLDO_STEP                 | Main LDO output voltage control step                   |   |      | 0.5  |      | v    |
| I <sub>OUT_MLDO</sub>          | Main LDO output current range                          |   |      |      | 1.7  | А    |
| P <sub>SRR_MLDO</sub>          | Main LDO power supply rejection ratio                  | C <sub>VOUT</sub> =3.3uF<br>DC to 100MHz                                  | 20   |      |      | dB   |
| Internal LDO                   |  |   |      |      |      |      |
| Vout_vdd_5v                    | Internal VDD_5V LDO output voltage<br>range            | V <sub>RECT</sub> >5V,<br>C <sub>VDD_5V</sub> =1uF,<br>External load<30mA | 4.62 | 5    | 5.38 | v    |
| VOUT_VDD_DIG                   | Internal VDD_DIG LDO output voltage range              | V <sub>RECT</sub> >3V,<br>C <sub>VDD_DIG</sub> =1uF<br>External load<30mA | 2.85 | 3    | 3.32 | v    |
| BGR                            |  |   |      |      |      |      |

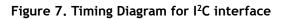


**CWQ1100** Qi Compliant 15W Wireless Power Receiver IC

| V <sub>BGR</sub>        | Internal BGR output voltage<br>Register programmable                                | V <sub>RECT</sub> >3V                                  |      | 1.22  |      | v     |
|-------------------------|---|--|------|-------|------|-------|
| Oscillator              |   |  |      |       |      |       |
| f <sub>osc</sub>        | Internal oscillator frequency<br>Register programmable                              | V <sub>RECT</sub> >3V                                  |      | 15    |      | MHz   |
| ADC                     |   |  |      |       |      |       |
| N <sub>ADC</sub>        | ADC resolution  | V <sub>RECT</sub> >3V                                  |      | 12    |      | bit   |
| f <sub>sample</sub>     | ADC sampling rate   | f <sub>osc</sub> =15MHz                                |      | 217   |      | kSa/s |
| N <sub>CH_ADC</sub>     | ADC channel   |  |      | 7     |      |       |
| ENB/CHG_DO              | WN  | -  |      |       |      |       |
| V <sub>IH</sub>         | ENB/CHG_DOWN input threshold high   |  | 1.5  |       |      | V     |
| V <sub>IL</sub>         | ENB/CHG_DOWN input threshold low  |  |      |       | 0.5  | V     |
| Protection              |   | •  |      |       |      |       |
| V <sub>OVP</sub>        | VRECT over voltage protection<br>Register programmable                              | V <sub>RECT</sub> : 5V to 16V                          | 14.8 | 15    | 15.2 | v     |
| V <sub>OVP_HYS</sub>    | OVP hysteresis  | V <sub>RECT</sub> : 16V to 5V                          |      | 1.5   |      | V     |
| I <sub>OCL</sub>        | I <sub>OUT</sub> over current limit protection<br>Programmable by R <sub>ILIM</sub> | R <sub>ILIM</sub> =24kΩ<br>I <sub>OUT</sub> : 0A to 2A |      | 1.875 |      | А     |
| I <sub>OCL_HYS</sub>    | OCL hysteresis  | Ι <sub>ουτ</sub> : 2Α to 0Α                            |      | 50    |      | mA    |
| TOTP                    | Over temperature protection<br>Thermal shutdown temperature                         | Temperature:<br>30°C to 160°C                          |      | 150   |      | °C    |
| T <sub>otp_hys</sub>    | OTP hysteresis  | Temperature:<br>160°C to 30°C                          |      | 20    |      | °C    |
| V <sub>TS_HOT</sub>     | EXT_TS hot temperature protection threshold voltage                                 | $V_{EXT_TS}$ : 0V to 0.5V                              |      | 0.315 |      | v     |
| V <sub>TS_HOT_HYS</sub> | V <sub>TS_HOT</sub> hysteresis  | $V_{\text{EXT}\_\text{TS}}$ : 0.5V to 0V               |      | 20    |      | mV    |
| $V_{TS_{COLD}}$         | EXT_TS cold temperature protection threshold voltage                                | V <sub>EXT_TS</sub> : 0.5V to 1.5V                     |      | 0.980 |      | v     |
| VTS_COLD_HYS            | V <sub>TS_COLD</sub> hysteresis   | V <sub>EXT_TS</sub> : 1.5V to 0.5V                     |      | 80    |      | mV    |

# 6. I<sup>2</sup>C Signal Timing







| Symbol              | Description                                    | Conditions                      | Min. | Тур. | Max. | Unit |
|---------------------|--|---------------------------------|------|------|------|------|
| V <sub>IL_SDA</sub> | Input low threshold level SDA                  | V <sub>PULLUP</sub> =VDD_DIG=3V |      |      | 0.7  | V    |
| V <sub>IH_SDA</sub> | Input high threshold level SDA                 | V <sub>PULLUP</sub> =VDD_DIG=3V | 2.3  |      |      | V    |
| V <sub>IL_SCL</sub> | Input low threshold level SCL                  | V <sub>PULLUP</sub> =VDD_DIG=3V |      |      | 0.7  | V    |
| V <sub>IH_SCL</sub> | Input high threshold level SCL                 | V <sub>PULLUP</sub> =VDD_DIG=3V | 2.3  |      |      | V    |
| f <sub>SCL</sub>    | SCL clock frequency                            |                                 |      |      | 400  | kHz  |
| t <sub>LOW</sub>    | SCL clock low time                             |                                 | 1.3  |      |      | us   |
| t <sub>нібн</sub>   | SCL clock high time                            |                                 | 0.6  |      |      | us   |
| tr                  | Rise time of both SDA and SCL                  |                                 |      |      | 0.3  | us   |
| t <sub>f</sub>      | Fall time of both SDA and SCL                  |                                 |      |      | 0.3  | us   |
| t <sub>su,sta</sub> | Setup time for START condition                 |                                 | 0.6  |      |      | us   |
| t <sub>hd,sta</sub> | Hold time for START condition                  |                                 | 0.6  |      |      | us   |
| t <sub>su,dat</sub> | Data setup time                                |                                 | 0.1  |      |      | us   |
| t <sub>hd,dat</sub> | Data hold time                                 |                                 |      |      | 0.9  | us   |
| t <sub>su,sto</sub> | Setup time for STOP condition                  |                                 | 0.6  |      |      | us   |
| t <sub>BF</sub>     | Bus free time between STOP and START condition |                                 | 1.3  |      |      | us   |

Table 3. I<sup>2</sup>C Characteristics



## **Revision History**

| Date       | Version No. | Description  |  |  |  |  |
|------------|-------------|--|--|--|--|--|
| 2017/07/27 | 1.0         | Preliminary Release                                |  |  |  |  |
| 2017/09/15 | 1.1         | Initial Formal Version                             |  |  |  |  |
| 2017/12/28 | 2.0         | Added QFN package information                      |  |  |  |  |
| 2018/8/28  | 2.1         | Modify Sales Contact point                         |  |  |  |  |
| 2018/5/04  | 2.2         | Updated EC table and description, add register map |  |  |  |  |

# Ordering Information

| Part<br>Number | Package Type                     | Shipping<br>Carrier | Package<br>Qty | Eco<br>Plan               | MSL Peak Temp      | Description               | Device<br>Marking |
|----------------|----------------------------------|---------------------|----------------|---------------------------|--------------------|---------------------------|-------------------|
| CWQ1100-W5     | WLCSP 50,<br>2.64mm x 3.94<br>mm | Tape and Reel       |                | Green<br>(RoHS&noSb/Br)   | Level-1-260C-UNLIM | VOUT=5V(BPP),<br>5V(EPP)  |                   |
| CWQ1100-W9     | WLCSP 50,<br>2.64mm x<br>3.94mm  | Tape and Reel       |                | Green<br>(RoHS& no Sb/Br) | Level-1-260C-UNLIM | VOUT=5V(BPP),<br>9V(EPP)  |                   |
| CWQ1100-WC     | WLCSP 50,<br>2.64mm x<br>3.94mm  | Tape and Reel       |                | Green<br>(RoHS& no Sb/Br) | Level-1-260C-UNLIM | VOUT=5V(BPP),<br>12V(EPP) |                   |
| CWQ1100-Q5     | QFN 40,<br>6mm x 6mm             | Tray                |                | Green<br>(RoHS&noSb/Br)   |                    | VOUT=5V(BPP),<br>5V(EPP)  |                   |
| CWQ1100-Q9     | QFN 40,<br>6mm x 6mm             | Tray                |                | Green<br>(RoHS& no Sb/Br) |                    | VOUT=5V(BPP),<br>9V(EPP)  |                   |
| CWQ1100-QC     | QFN 40,<br>6mm x 6mm             | Tray                |                | Green<br>(RoHS& no Sb/Br) |                    | VOUT=5V(BPP),<br>12V(EPP) |                   |



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